# POWER RELAY 1 POLE—8 A (MEDIUM LOAD CONTROL)

# **JS SERIES**

#### FEATURES

- UL, CSA, VDE, SEV, SEMKO, FIMKO, NEMKO, DEMKO, ÖVE, CQC, BSI compliance
- UL class B (130°C) insulation
- 1 form A (SPST-NO) or 1 form C (SPDT) contact
- Low profile and space saving—Height: 12.5 mm —Mounting space: 290 mm<sup>2</sup>
- High sensitivity in small package
  —Operating power ...... 110 to 140 mW
  - -Nominal power..... 220 to 290m W
- High isolation in small package
  - -Insulation distance : 8 mm (between coil and contacts)
- —Dielectric strength : 5,000 VAC
- —Surge strength : 10,000 V
- Plastic materials
  - -UL 94 flame class V-0
- —UL CTI level class 2
- Plastic sealed type
- Various contact material options
- RoHS compliant since date code: 0438B9, 0434R Please see page 7 for more information

### ORDERING INFORMATION

[Example]  $\frac{JS}{(a)} \stackrel{-}{(*)} \frac{12}{(b)} \stackrel{M}{(c)} \stackrel{E}{(d)} -$ 

 $\frac{E}{(d)} - \frac{K}{(e)} \frac{T}{(f)} - \frac{(V3)^*}{(j)}$ 

<u> </u>				
(a)	Series Name	JS : JS Series		
(b)	Nominal Voltage	Refer to the COIL DATA CHART		
(c)	Contact Arrangement	Nil : 1 form C (SPDT) M : 1 form A (SPST-NO)		
(d)	Contact Material	Nil : Gold plate silver cadmium oxide D : Silver nickel E : Silver cadmium oxide F : Gold plate silver nickel N : Gold plate silver tin oxide		
(e)	Enclosure	K : Plastic sealed type		
(f)	Construction	Nil: 3.2 mm T : 5.0 mm (only JS-MN, MD, MF)		
(j)	For low current application	Nil: $0.3\mu$ gold overlay (available with Nil, N and F contact) V3: $3\mu$ gold overlay for lower current applications (available with Nil, N) and not available for T (5.0mm type)		

# **RoHS compliant**





#### ■ PART NUMBERS

1. Terminal Pitch: 3.2mm

Order P/N	Series	Voltage	Contact Arrangement	Contact material	Enclosure	Terminal Pitch	Special
JS-5M ()-K(-V3)		5					
JS-6M ( )-K(-V3)		6					
JS-9M ( )-K(-V3)		9		Nil: Gold plate +			
JS-12M ( )-K(-V3)		12	M: 1 form A	silver cadmium		3.2 mm	Gold plate Nil: 0.3 μm V3: 3 μm
JS-18M ( )-K(-V3)		18	M: 1 form A	oxide	K: Plastic Seal		
JS-24M ( )-K(-V3)		24		E: Silver cadmium oxide N: Gold plate silver tin oxide F: Gold plate silver nickel I: 1 form C D: Silver nickel			
JS-48M ( )-K(-V3)		48					
JS-60M ()-K(-V3)	JS	60					
JS-5 ( )-K(-V3)	13	5	Nill 1 form C				
JS-6 ( )-K(-V3)		6					
JS-9 ( )-K(-V3)		9					
JS-12 ( )-K(-V3)		12					
JS-18 ( )-K(-V3)		18					
JS-24 ( )-K(-V3)		24					
JS-48 ( )-K(-V3)		48					
JS-60 ( )-K(-V3)		60					

# 2. Terminal Pitch: 5.0mm

Order P/N	Series	Voltage	Contact Arrangement	Contact material	Enclosure	Terminal Pitch
JS-5MN-K		5				
JS-6MN-K		6				
JS-9MN-K	]	9				
JS-12MN-K		12	M: 1 form A	N: Gold plate silver + tin oxide	K	T: E 0 mm
JS-18MN-K	JS	18	M. I IOIIIIA	+ lin oxide	K	T: 5.0 mm
JS-24MN-K	]	24				
JS-48MN-K		48				
JS-60MN-K		60				

#### ■ COIL DATA CHART

Coil voltage	Nominal voltage	Maximum voltage* <sup>1</sup>	Coil resistance (±10%)	Must operate voltage* <sup>2</sup>	Must release voltage* <sup>2</sup>	Nominal Power
5	5 VDC	11.8 VDC	112 Ω	3.5 VDC	0.5 VDC	225 mW
6	6 VDC	14.1 VDC	160 Ω	4.2 VDC	0.6 VDC	225 mW
9	9 VDC	21.2 VDC	360 Ω	6.3 VDC	0.9 VDC	225 mW
12	12 VDC	28.3 VDC	660 Ω	8.5 VDC	1.2 VDC	220 mW
18	18 VDC	42.4 VDC	1,455 Ω	12.7 VDC	1.8 VDC	225 mW
24	24 VDC	56.6 VDC	2,350 Ω	16.8 VDC	2.4 VDC	245 mW
48	48 VDC	105.6 VDC	8,000 Ω	33.4 VDC	4.8 VDC	290 mW
60	60 VDC	132.0 VDC	12,500 Ω	41.7 VDC	6.0 VDC	290 mW

Note : All values in the table are measured at 20°C.

\*1: No contact current at 20°C.

\*2: Specified values are subject to pulse wave voltage.

# ■ SPECIFICATIONS

Item			Non-V3 type	V3 type	
			JS ( )-E-K, JS ( )-K, JS ( )-N-K, JS ( )-F-K, JS ( )-D-K	JS ( )-K, JS ( )N-K	
Contact	Arrangement		1 Form C (SPDT), 1 Form A (SPST-NO)		
	Material		0.3µ Ag plated	3µ Ag plated	
	Configuration		Single,		
	Resistance (ini	tial)	Max. 100mΩ 1A, 6VDC)	Max. 30mΩ (1A 6VDC)	
	Rating		8A 250 VAC / 24 VDC		
	Max. carrying current		10A		
	Max. switching	power	2,000 VA / 192 W		
	Max. switching voltage		400 VAC/ 150 VDC		
	Min. switching load		100 mA 5 VDC	10 mA 5 VDC	
Coil	Nominal power (at 20°C)		220 to 290 mW		
	Operate power (at 20°C)		110 to 140 mW		
	Operating tem	perature (at 20°C)	-40°C to +85°C (no frost)		
Time value	Operate		Max. 10 ms (at nominal voltage, without bounce)		
	Release (without diode)		Max. 5 ms (at nominal voltage, without bounce)		
Life	Mechanical		Min. 20x10 <sup>6</sup> operations		
	Electrical	AC rated load	Min. 100x10 <sup>6</sup> operations (JS-()N-K min. 10x10 <sup>3</sup> ops.)		
		DC rated load	Min. 100x10 <sup>6</sup> operations (JS-()N-K min. 10x10 <sup>3</sup> ops.)		
Vibration resistance	Misoperation		10 to 55 Hz at double amplitude of 1.65 mm		
	Endurance		10 to 55 Hz at double amplitude of 3.3 mm		
Shock	Misoperation		Min. 100 m/s <sup>2</sup> (11±1 ms)		
resistance	Endurance		Min. 1,000 m/s <sup>2</sup> (6±1 ms)		
Weight			Approx. 8 g		

#### ■ INSULATION

Items			
Resistive (at 500 VDC)		Min. 1,000 MΩ	
Dielectric Strength	Open contacts	1,000 VAC (50/60 Hz) 1 min.	
	Coil and contacts	5,000 VAC (50/60 Hz) 1 min.	
Surge strength (coil an	d contacts)	10,000 V (1.2 x 50 µs standard wave)	
Clearance / crepage		8 mm / 8 mm	
Isolation (DIN EN 61810-1 VDE 0435)			
Voltage		250 V	
Pollution		3	
Isolation material group		III a	
Isolation category / Re	ference voltage (VDE 01106)	C / 250V	

#### ■ SAFETY STANDARD (VDE 01106)

Туре	Compliance	Contact rating			
UL	UL 508 E 56140	Flammability: UL 94-V0 (plastics)			
		Contact material: Nil, E	Ν		
CSA	C22.2 No. 14 LR 35579	8 A 24 VDC (resistive) 100k 8 A, 250 VDC (resistive) 100k 10 A, 30 VDC (resistive) 10 A, 250 VAC (resistive) 1/4 HP, 125 V/ 250 VAC 1/3 HP, 125 VAC 1/2 HP, 250 VAC Pilot duty: C150, B300 Pilot duty: 0.27A, 250VDC	8 A 24 VDC (resistive) 100k 8 A, 250 VDC (resistive) 100k 10 A, 30 VDC (resistive) 10 A, 250 VAC (resistive) 1/4 HP, 125 V/ 250 VAC 1/3 HP, 125 VAC 1/2 HP, 250 VAC Pilot duty: A300, B300 C150, R300		
VDE	0435, 0631, 0700	8 A 250 VAC (cos Ø=1) 8 A 24 VDC (0 ms)			
SEMKO	EN 61058-1 + A1: 1993 EN 61095:1993 + A11	Rated Voltage (V): 250 Rated Current (A): 8 (2) or 8			

Also complies with SEV, ÖVE, FIMKO, BSI, CQC, NEMKO, DEMKO

#### CHARACTERISTIC DATA



REFERENCE DATA











#### ■ DIMENSIONS



# **RoHS Compliance and Lead Free Relay Information**

# 1. General Information

- Relays produced after the specific date code that is indicated on each data sheet are lead-free now. All of our signal and power relays are lead-free. Please refer to Lead-Free Status Info. (http://www.fujitsu.com/us/downloads/MICRO/fcai/relays/lead-free-letter.pdf)
- Lead free solder paste currently used in relays is Sn-3.0Ag-0.5Cu.
- All signal and power relays also comply with RoHS. Please refer to individual data sheets. Relays that are RoHS compliant do not contain the 5 hazardous materials that are restricted by RoHS directive (lead, mercury, chromium IV, PBB, PBDE).
- It has been verified that using lead-free relays in leaded assembly process will not cause any problems (compatible).
- "LF" is marked on each outer and inner carton. (No marking on individual relays).
- To avoid leaded relays (for lead-free sample, etc.) please consult with area sales office.
- We will ship leaded relays as long as the leaded relay inventory exists.

Note: Cadmium was exempted from RoHS on October 21, 2005. (Amendment to Directive 2002/95/EC)

# 2. Recommended Lead Free Solder Profile

• Recommended solder paste Sn-3.0Ag-0.5Cu.

#### **Reflow Solder condtion**

#### Flow Solder condtion:

Pre-heating: maximum 120°C Soldering: dip within 5 sec. at 260°C soler bath

#### Solder by Soldering Iron:

Soldering Iron Temperature: maximum 360°C Duration: maximum 3 sec.

### We highly recommend that you confirm your actual solder conditions

### 3. Moisture Sensitivity

• Moisture Sensitivity Level standard is not applicable to electromechanical realys.

### 4. Tin Whisker

• Dipped SnAgCu solder is known as low risk tin whisker. No considerable length whisker was found by our in house test.

#### **Fujitsu Components International Headquarter Offices**

Japan Fujitsu Component Limited Gotanda-Chuo Building 3-5, Higashigotanda 2-chome, Shinagawa-ku Tokyo 141, Japan Tel: (81-3) 5449-7010 Fax: (81-3) 5449-2626	Europe Fujitsu Components Europe B.V. Diamantlaan 25 2132 WV Hoofddorp Netherlands Tel: (31-23) 5560910 Fax: (31-23) 5560950
Email: promothg@ft.ed.fujitsu.com	Email: info@fceu.fujitsu.com
Web: www.fcl.fujitsu.com	Web: emea.fujitsu.com/components/
North and South America	Asia Pacific
Fujitsu Components America, Inc.	Fujitsu Components Asia Ltd.
250 E. Caribbean Drive	102E Pasir Panjang Road
Sunnyvale, CA 94089 U.S.A.	#01-01 Citilink Warehouse Complex
Tel: (1-408) 745-4900	Singapore 118529
Fax: (1-408) 745-4970	Tel: (65) 6375-8560
Email: components@us.fujitsu.com	Fax: (65) 6273-3021
Web: http://www.fujitsu.com/us/services/edevices/components/	Email: fcal@fcal.fujitsu.com
	Web: http://www.fujitsu.com/sg/services/micro/components/

©2007 Fujitsu Components America, Inc. All rights reserved. All trademarks or registered trademarks are the property of their respective owners.

Fujitsu Components America or its affiliates do not warrant that the content of datasheet is error free. In a continuing effort to improve our products Fujitsu Components America, Inc. or its affiliates reserve the right to change specifications/datasheets without prior notice. Rev. September 27, 2007